

6N65

Power MOSFET

6.2A, 650V N-CHANNEL POWER MOSFET

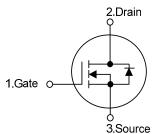
DESCRIPTION

The UTC **6N65** is a high voltage power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in high speed switching applications of switching power supplies and adaptors.

FEATURES

- * $R_{DS(ON)}$ < 1.7 Ω @V_{GS} = 10V
- * Fast switching capability
- * Avalanche energy tested
- * Improved dv/dt capability, high ruggedness

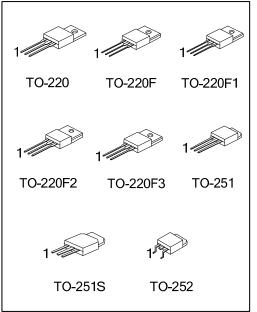
SYMBOL



ORDERING INFORMATION

Ordering Number		Deekege	Pin Assignment			Decking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
6N65L-TA3-T	6N65G-TA3-T	TO-220	G	D	S	Tube	
6N65L-TF3-T	6N65G-TF3-T	TO-220F	G	D	S	Tube	
6N65L-TF1-T	6N65G-TF1-T	TO-220F1	G	D	S	Tube	
6N65L-TF2-T	6N65G-TF2-T	TO-220F2	G	D	S	Tube	
6N65L-TF3T-T	6N65G-TF3T-T	TO-220F3	G	D	S	Tube	
6N65L-TM3-T	6N65G-TM3-T	TO-251	G	D	S	Tube	
6N65L-TMS-T	6N65G-TMS-T	TO-251S	G	D	S	Tube	
6N65L-TN3-T	6N65G-TN3-T	TO-252	G	D	S	Tube	
6N65L-TN3-R	6N65G-TN3-R	TO-252	G	D	S	Tape Reel	
Note: Pin Assignment: G: Gate D: Drain S: Source							
		(1) T. Tubo P. T	ana Paa	1			

6N65 <u>L-TA3</u> - <u>T</u>	(1) T: Tube, R: Tape Reel
(1)Packing Type	(2) TA3: TO-220, TF3: TO-220F, TF1: TO-220F1,
(2)Package Type	TF2: TO-220F2, TF3T: TO-220F3, TM3: TO-251,
(3)Lead Free	TMS: TO-251S, TN3: TO-252
	(3) L: Lead Free, G: Halogen Free



MARKING INFORMATION

PACKAGE	MARKING
TO-220	
TO-220F	
TO-220F1	UTC UTC
TO-220F2	6N65
TO-220F3	Lot Code
TO-251	
TO-251S	
TO-252	



PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V _{DSS}	650	V
Gate-Source Voltage		V _{GSS}	±30	V
Avalanche Current (Note 2)		I _{AR}	6.2	А
Continuous Drain Curr	Continuous Drain Current		6.2	А
Pulsed Drain Current (Note 2)		I _{DM}	24.8	А
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	440	mJ
Peak Diode Recovery	eak Diode Recovery dv/dt (Note 4)		4.5	ns
	TO-220	P _D	125	W
	TO-220F/TO-220F1 TO-220F3		40	W
Power Dissipation	TO-220F2		42	W
	TO-251/TO-251S TO-252		55	W
Junction Temperature		TJ	+150	°C
Operating Temperature		T _{OPR}	-55 ~ +150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

■ ABSOLUTE MAXIMUM RATINGS (T_c = 25°C, unless otherwise specified)

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by $T_{\rm J}$

3. L = 24mH, I_{AS} = 6A, V_{DD} = 90V, R_G = 25 Ω , Starting T_J = 25°C

4. I_{SD} ≤ 6.2A, di/dt ≤200A/µs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C

THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT	
Junction to Ambient	TO-220/TO-220F TO-220F1/TO-220F2 TO-220F3	θυΑ	62.5	°C/W	
	TO-251/TO-251S TO-252		110		
Junction to Case	TO-220		1.0		
	TO-220F/TO-220F1 TO-220F3	0	3.2	°C/W	
	TO-220F2	θ _{JC}	2.97		
	TO-251/TO-251S TO-252		2.27		



PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS	OTHEOL				100 0 0	0.111
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D = 250µA	650			V
Drain-Source Leakage Current	I _{DSS}	$V_{DS} = 650V, V_{GS} = 0V$			10	μA
Forward	loss	$V_{GS} = 30V, V_{DS} = 0V$			100	nA
Gate- Source Leakage Current Reverse		$V_{GS} = -30V, V_{DS} = 0V$			-100	nA
Breakdown Voltage Temperature Coefficient	$\triangle BV_{DSS} / \triangle T_{J}$	I _D =250μA, Referenced to 25°C		0.53		V/°C
ON CHARACTERISTICS	•	+ = +				
Gate Threshold Voltage	V _{GS(TH)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance	R _{DS(ON)}	$V_{GS} = 10V, I_D = 3.1A$		1.1	1.7	Ω
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{ISS}			950	1200	pF
Output Capacitance	C _{oss}	V _{DS} =25V, V _{GS} =0V,		95	120	pF
Reverse Transfer Capacitance	C _{RSS}	f=1.0 MHz		18	25	pF
SWITCHING CHARACTERISTICS	•	·				
Turn-On Delay Time	t _{D(ON)}			45	60	ns
Turn-On Rise Time	t _R	V _{DD} =325V, I _D =6.2A,		100	130	ns
Turn-Off Delay Time	t _{D(OFF)}	R _G =25Ω (Note 1, 2)		300	400	ns
Turn-Off Fall Time	t _F			220	270	ns
Total Gate Charge	Q _G			180	200	nC
Gate-Source Charge	Q _{GS}	V_{DS} =520V, I_{D} =6.2A,		8		nC
Gate-Drain Charge	Q _{GD}	V _{GS} =10V (Note 1, 2)		20		nC
DRAIN-SOURCE DIODE CHARACTERISTIC	CS AND MAXI	MUM RATINGS	_	_	_	_
Drain-Source Diode Forward Voltage	V _{SD}	V _{GS} = 0 V, I _S = 6.2 A			1.4	V
Maximum Continuous Drain-Source Diode					6.0	Δ
Forward Current	I _S				6.2	A
Maximum Pulsed Drain-Source Diode					24.8	А
Forward Current	I _{SM}				24.0	~
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, I _S = 6.2 A,		290		ns
Reverse Recovery Charge	Q _{RR}	dI _F /dt = 100 A/µs (Note 1) 2.		2.35		μC

■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

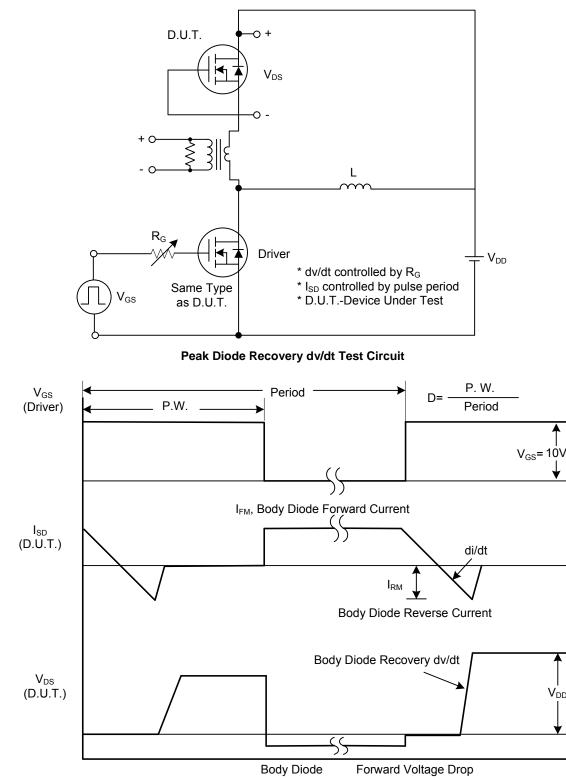
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%

2. Essentially independent of operating temperature



6N65

TEST CIRCUITS AND WAVEFORMS



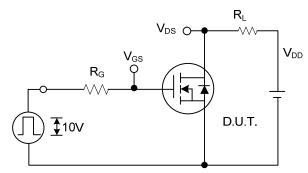
Peak Diode Recovery dv/dt Waveforms



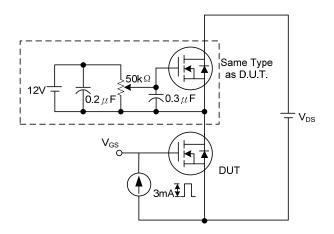
 V_{DD}

6N65

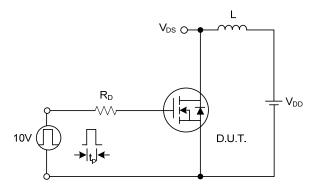
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



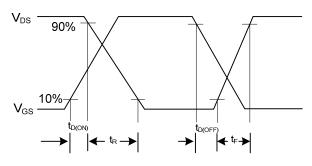




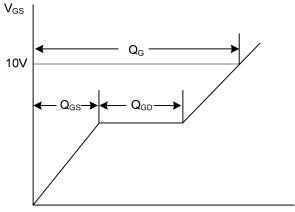
Gate Charge Test Circuit



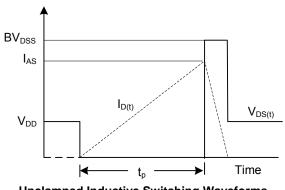
Unclamped Inductive Switching Test Circuit



Switching Waveforms



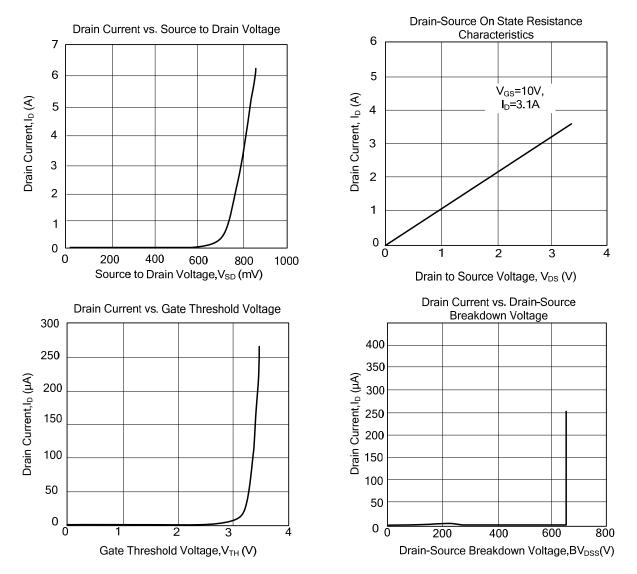
Charge Gate Charge Waveform



Unclamped Inductive Switching Waveforms



TYPICAL CHARACTERISTICS



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